

PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE
Express Mail Label No.: EL 961 108 221 US
Attorney Docket No.: Komatsu Case 267A
January 29, 2004

Inventors: (1) Toru IMORI, (2) Masashi KUMAGAI and
(3) Junnosuke SEKIGUCHI

Title: METAL PLATING METHOD, PRETREATMENT AGENT,
AND SEMICONDUCTOR WAFER AND SEMICONDUCTOR
DEVICE OBTAINED USING THESE

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is a request for filing a continuation-in-part application
under 37 CFR 1.53(b) of pending prior application:

Inventors: (1) Toru IMORI, (2) Masashi KUMAGAI and
(3) Junnosuke SEKIGUCHI

Serial No.: 10/169 778 Filing Date: July 2, 2002

Group: 2812 Examiner: Nguyen

Title: METAL PLATING METHOD, PRETREATMENT AGENT,
AND SEMICONDUCTOR WAFER AND SEMICONDUCTOR
DEVICE OBTAINED USING THESE

The disclosure of this prior parent application, as well as any
applications from which this prior application may claim
priority, is hereby incorporated by reference.

[] This application is filed by fewer than all the inventors named
in the prior application. **DELETE** the following inventor(s)
named in the prior non-provisional application: _____.

Please direct correspondence to the address associated with the
following customer number:

23474

FLYNN, THIEL, BOUTELL & TANIS, P.C.
(FIRM)

Enclosed are:

- ☒ New specification.
 - ☐ Marked-up version of specification showing changes to prior parent application (optional).
- ☐ Copy of prior specification.
- ☐ Amend the specification by inserting before line 1 of page 1, the sentence:
---This is a of Serial No. 10/169 778, filed July 2, 2002, which was the national stage of International Application No. PCT/JP00/08166, filed November 20, 2000, which International Application published in English.---
- ☒ Declaration or Oath, which is:
 - ☒ New
 - ☐ A copy of the Declaration or Oath from the prior application.
- ☒ 1 Drawing Sheet ☒ Formal ☐ Informal
- ☐ Cancel in this application Claims of the present application before calculating the filing fee. (Retain at least one independent claim.)
- ☐ Preliminary Amendment Canceling Claims (Please enter before calculating the filing fee.)
- ☐ Amendment Before First Office Action
- ☐ Information Disclosure Statement
- ☐ Small entity status is claimed. See 37 CFR 1.27.
 - ☐ Statement(s) re small entity is/are enclosed.
- ☒ The prior application is assigned of record to Nikko Materials Co., Ltd.
- ☒ New Assignment and Transmittal therefor
- ☒ Acknowledgment Postal Card
- ☒ Priority is claimed under 35 USC 119 based on Japan Application No. 2000-1645, filed January 7, 2000 and Application No. 2000-238047, filed August 7, 2000.
 - ☒ The certified copies have been filed in prior application Serial No. PCT/JP00/08166, filed November 20, 2000.

PATENT APPLICATION

"Express Mail" Mailing Label No.: EL 961 108 221 US

Date of Mailing: January 29, 2004

Applicants: Toru IMORI et al

Title: METAL PLATING METHOD, PRETREATMENT AGENT, AND
SEMICONDUCTOR WAFER AND SEMICONDUCTOR DEVICE
OBTAINED USING THESE

Serial No.: Unknown

Confirmation No.: Unknown

Filed: Unknown

Atty Docket No.: Komatsu Case 267A

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

EXPRESS MAILING CERTIFICATE

Sir:

I hereby certify that the attached paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

FLYNN, THIEL, BOUTELL & TANIS, P.C.

By: 

Date: January 29, 2004

Documents attached: CIP Application Transmittal
dated January 29, 2004
including enclosures listed thereon

Telephone: (269) 381-1156

191.05/03

The filing fee is calculated as shown below, after entering any enclosed Amendment which requests entry before such calculation:

| For | No. Filed | No. Extra | (X) LG Entity | RATE | () SM Entity | Fee |
|------------------------------|--------------|--------------|------------------|----------|------------------|-----------|
| Basic Fee | | | | \$770.00 | \$385.00 | \$770.00 |
| Total Claims | (7 - 20 = 0) | | x \$ 18.00 | | x \$ 9.00 | |
| Indep. Claims | (2 - 3 = 0) | | x \$ 86.00 | | x \$ 43.00 | |
| [] Multiple Dep. Claim | | | + \$290.00 | | + \$145.00 | |
| * * * TOTAL FILING FEE * * * | | | | | | \$ 770.00 |

[X] A Check for \$810.00 is enclosed to cover fees.

[X] The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or to credit any overpayment to Deposit Account No. 06-1382. A duplicate copy of this sheet is enclosed.

[X] Any additional filing fees required under 37 CFR 1.16

[X] The Power of Attorney in the prior application is to Dale H. Thiel (Reg. No. 24323), David G. Boutell (Reg. No. 25072), Ronald J. Tanis (Reg. No. 22724), Terryence F. Chapman (Reg. No. 32549), Mark L. Maki (Reg. No. 36589), David S. Goldenberg (Reg. No. 31257), Sidney B. Williams, Jr. (Reg. No. 24949), Liane L. Churney (Reg. No. 40694) and Brian R. Tumm (Reg. No. 36328), all of 2026 Rambling Road, Kalamazoo, Michigan 49008.

[X] The Power appears in the original papers in the prior application.

The undersigned is: [X] an attorney of record in the prior application

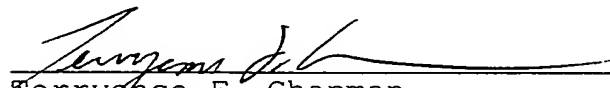
Please direct all telephone calls to the undersigned at telephone number (269) 381-1156.

Respectfully submitted,

FLYNN, THIEL, BOUTELL & TANIS, P.C.

IN DUPLICATE

TFC/smd


Terryence F. Chapman
Reg. No. 32 549

Encl: Listed above

103.10/03



PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

January 29, 2004

Applicants: Toru IMORI et al

For: METAL PLATING METHOD, PRETREATMENT AGENT,
AND SEMICONDUCTOR WAFER AND SEMICONDUCTOR DEVICE
OBTAINED USING THESE

Serial No.: 10/169 778

Group: 2812

Confirmation No.: 7308

Filed: July 2, 2002

Examiner: Nguyen

International Application No.: PCT/JP00/08166

International Filing Date : November 20, 2000

Atty. Docket No.: Komatsu Case 267

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

PETITION FOR TIME EXTENSION

Sir:

An extension is required to facilitate filing of a
continuation-in-part application. Pursuant to 37 CFR
1.136(a), please extend the shortened period for response by
one month. The extension fee is:

[X] \$110.00 (37 CFR 1.17)


A check for \$110.00 is enclosed to cover fees.

If this Petition is not timely received, please extend the
shortened period an additional month. Please credit any over-
payment, or charge any additional fee required by this
Petition, to Deposit Account No. 06-1382. A duplicate of this
Petition is enclosed.

Respectfully submitted,

IN DUPLICATE

TFC/smd


Terryence F. Chapman

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& TANIS, P.C.
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| | |
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| Steven R. Thiel | Reg. No. 53 685 |
| Sidney B. Williams, Jr. | Reg. No. 24 949 |

Encl: Check
Postal Card

182.10/03